

# Gaurav Khadasane

## Hardware Engineer – PCB Design

- Requirement Analysis, Specification Document Creation, Proposal Document creation.
- Experience as a Hardware board Design, High Speed PCB Design up to 12 layers and Power Devices layouts.
- Cadence Allegro, Proteus, Eagle, Altium Designer, Expedition, Hyperlynx.
- CAM350 for Gerber viewing and editing, View Mate Gerber viewing.
- Team Handling for PCB Design and Layout review for quality delivery.
- Layout timeline estimation and defining WBS for project management.

## WORK EXPERIENCE

### Motherson Technology and Services | Sr. PCB Design Engineer

April. 2022 – Till Date

- Layout Design for automotive breaking systems of Truck and trailers.
- Gerber, Assembly and Fabrication package generation.
- Maintain data on Company server and sharepoint.

### Technosoft Engineering | Hardware Engineer - NPD

July. 2021 - March. 2022

- Capture Requirement specification to prepare Project Report on requirement as per stakeholders
- Project Scheduling and Monitoring for requirement Phase and Hardware design Phases
- RFQ to fabrication and assembly house for quotation and issues resolve alternative parts and assembly instruction.

### Pegasus Infocorp, Client: Johnson Control | Sr Engineer PCB Design

August. 2020 - July. 2021

- PCB Design for new products on fire detection systems.
- Library creation for Altium design, symbol and Footprint w.r.t checklist and IPC Std
- Work Independently and liaise with H/W and Mech Team for overall Product DFM, DFT, DFA

### Capgemini | Associate Consultant – PCB Design

Jan. 2019 - Feb. 2020

- High Speed PCB design 6 layers.
- Creating and modifying schematic for Layout changes as per ECO documents.
- Managing product documents for Assembly Fabrication drawing and gerber generation.

### Interfab Electronics | Sr Design Engineer – Product Development

Nov. 2015 - Dec. 2018

- Reviewing and finalizing Hardware, Layouts, Footprints.
- New Product development for Industrial clients and their onsite test with certification.
- Component selection and Panelization and Gerber generation of final design.

## EDUCATION


### PG DIPLOMA Embedded systems, CDAC ,2015


Thakur College.


### B.E. Electronics and Telecommunication, Mumbai University, 2014

Yadavrao Tasgaonkar Institute of Engineering and Technology

## CONTACT

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## SOFTWARE

- Altium Designer 22
- Cadence OrCad 17.2
- Mentor Expedition
- Cadstar
- CAM350

## Certification

- ✓ IOT NodeMCU, MicroBytes, Mumbai
- ✓ Hardware Board Design, SchemaZen Technologies, Bangalore.

## Design Exposure

### Processors/Controllers:

ATMEL SAM9 Series processor, Atmega328, i.Max RT series Processor.

### IO Peripherals:

10/100Mbps Ethernet Controllers and PHYs, USB Controllers, Transceivers and UART.

### Memory Section:

DDR2, NAND Flash, QSPI NOR Flash.

### Wireless Module:

Quectel MC60 GSM/GPRS/GPS, Wifi 8255, Bluetooth HC06.

### Power Management:

DC-DC, LDO, Multiple O/P SMPS in reference design from Power Integration Tiny series and STMicroelectronics Viper series.